BLM9D3437-12AM

LDMOS 3-stage integrated Doherty MMIC

AMPLEON

Rev. 1 — 28 September 2020

Product data sheet

1. Product profile

1.1 General description

The BLM9D3437-12AM is a 3-stage 12 W fully integrated Doherty MMIC solution using Ampleon's state of the art GEN9 LDMOS technology. The carrier and peaking device, input splitter and output combiner are integrated in a single package. This multiband device is perfectly suited as a device in the frequency range from 3400 MHz to 3700 MHz. Available in LGA outline.

Table 1. Performance

Typical RF performance at T_{case} = 25 °C; I_{Dq} = 25 mA (driver and final stages) in a demo circuit; $V_{GSq(peaking)} = V_{GSq(carrier)} - 0.55$ V.

Test signal	f	V _{DS}	P _{L(AV)}	Gp	η _D	ACPR _{5M}
	(MHz)	(V)	(W)	(dB)	(%)	(dBc)
single carrier W-CDMA [1]	3550	28	1.58	31.3	32	-37

[1] Test signal: 3GPP test model 1; 64 DPCH; PAR = 7.2 dB at 0.01 % probability on CCDF.

1.2 Features and benefits

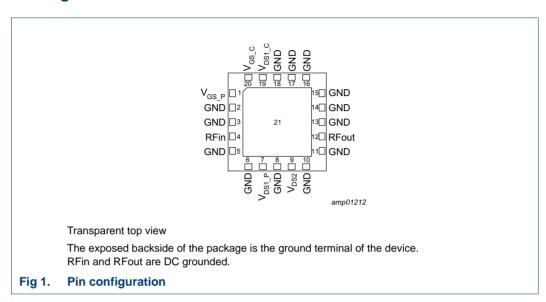
- Integrated input splitter
- Integrated output combiner
- Very high efficiency
- Designed for broadband operation (frequency 3400 MHz to 3700 MHz)
- Independent control of carrier and peaking bias
- Integrated ESD protection
- Excellent thermal stability
- High power gain, input and output matched to impedance 50 Ω
- For RoHS compliance see the product details on the Ampleon website

1.3 Applications

RF power MMIC for multi-carrier and multi-standard GSM, W-CDMA, LTE and NR small cell base stations in the 3400 MHz to 3700 MHz frequency range

2. Pinning information

2.1 Pinning



2.2 Pin description

Table 2. Pin description

Symbol	Pin	Description
V_{GS_P}	1	gate-source voltage of peaking
GND	2	ground
GND	3	ground
RFin	4	RF input
GND	5	ground
GND	6	ground
V _{DS1_P}	7	drain-source voltage of peaking driver
GND	8	ground
V _{DS2}	9	drain-source voltage of final stages
GND	10	ground
GND	11	ground
RFout	12	RF output
GND	13	ground
GND	14	ground
GND	15	ground
GND	16	ground
GND	17	ground
GND	18	ground

Pin description ... continued Table 2.

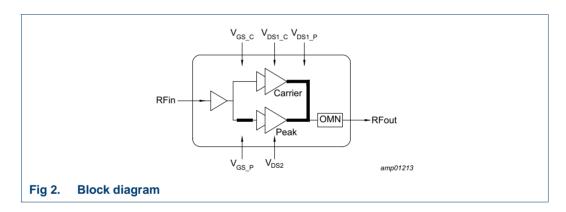
Symbol	Pin	Description
V _{DS1_C}	19	drain-source voltage of carrier driver
V _{GS_C}	20	gate-source voltage of carrier driver
GND	21	RF ground

Ordering information 3.

Table 3. **Ordering information**

Type number	Package	Package		
	Name	Description	Version	
BLM9D3437-12AM		plastic thermal enhanced package; no leads; 20 terminals; body 7.0 x 7.0 x 0.98 mm	LGA-7x7-20-2	

Block diagram 4.



Limiting values

Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{DS}	drain-source voltage		-	65	V
V_{GS}	gate-source voltage		-6	+11	V
T _{stg}	storage temperature		-55	+125	°C
Tj	junction temperature	[1]	-	175	°C
T _{case}	case temperature	[1]	-	125	°C

Continuous use at maximum temperature will affect the reliability. For details refer to the online MTF calculator.

6. Thermal characteristics

Table 5. Thermal characteristics

Measured for total device.

Symbol	Parameter	Conditions	Value	Unit
R _{th(j-c)}	thermal resistance from junction to	$T_{case} = 80 ^{\circ}C; P_{L(AV)} = 1.58 W$ [1]	11.1	K/W
	case	$T_{case} = 80 ^{\circ}C; P_{L(AV)} = 0.63 W$ [1]	9.4	K/W

^[1] When operated with a 1-carrier W-CDMA with PAR = 7.2 dB.

7. Characteristics

Table 6. DC characteristics

 $T_{case} = 25$ °C; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Carrier						
V_{GSq}	gate-source quiescent voltage	$V_{DS} = 28 \text{ V}; I_D = 25 \text{ mA}$	1.65	2	2.75	V
I _{GSS}	gate leakage current	V _{GS} = +11 V/-5 V; V _{DS} = 0 V	-	-	140	nA
Peaking						
I _{GSS}	gate leakage current	V _{GS} = +11 V/–5 V; V _{DS} = 0 V	-	-	140	nA
Final sta	ges				•	
I _{DSS}	drain leakage current	V _{GS} = 0 V; V _{DS} = 60 V	-	-	1.4	μΑ
Driver st	Driver stages					
I _{DSS}	drain leakage current	V _{GS} = 0 V; V _{DS} = 60 V	-	-	1.4	μΑ

Table 7. RF Characteristics

Typical RF performance at $T_{case} = 25$ °C; $V_{DS} = 28$ V; $I_{Dq} = 25$ mA (carrier); $V_{GSq(peaking)} = V_{GSq(carrier)} - 0.55$ V; $P_L = 1.58$ W; f = 3.7 GHz. Unless otherwise specified, measured in an Ampleon production circuit.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Test signal: CW pulsed			'			
Gp	power gain		27.5	30	-	dB
η _D	drain efficiency	P _L = 1.58 W	28	33.2	-	%
RLin	input return loss		-	-16	-8	dB
P _{L(3dB)}	output power at 3 dB gain compression		39.5	40.7	-	dBm

8. Application information

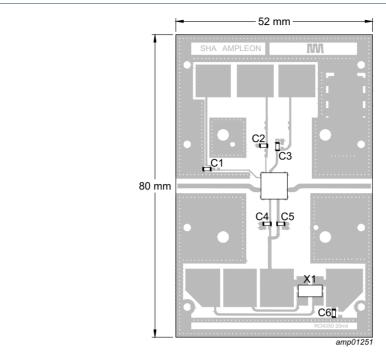
Table 8. Typical performance

Test signal: 1-carrier W-CDMA; $T_{case} = 25 \, ^{\circ}\text{C}$; $V_{DS} = 28 \, ^{\circ}\text{V}$; $I_{Dq} = 25 \, ^{\circ}\text{mA}$ (driver and final stages); test model 1; 64 DPCH; $PAR = 7.2 \, \text{dB}$ at 0.01 % probability CCDF; unless otherwise specified, measured in an Ampleon 3400 MHz to 3700 MHz frequency band demo circuit.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
P _{L(3dB)}	output power at 3 dB gain compression	f = 3550 MHz	[1]	-	40.4	-	dBm
η _D	drain efficiency	9 dB OBO (P _{L(AV)} = 32 dBm); f = 3550 MHz		-	32	-	%
Gp	power gain	P _{L(AV)} = 32 dBm; f = 3550 MHz		-	31.3	-	dB
G _{flat}	gain flatness	P _{L(AV)} = 32 dBm; f = 3400 MHz to 3700 MHz		-	0.5	-	dB
ACPR _{5M}	adjacent channel power ratio (5 MHz)	P _{L(AV)} = 32 dBm; f = 3550 MHz		-	-37	-	dBc
ΔG/ΔΤ	gain variation with temperature	f = 3550 MHz		-	0.07	-	dB/°C
K	Rollett stability factor	$T_{case} = -40$ °C; f = 0.15 GHz to 5 GHz	[2]	-	>1	-	

^[1] Pulsed CW power sweep measurement (δ = 10 %, t_p = 100 μ s).

^[2] S-parameters measured in a demo circuit.



Printed-Circuit Board (PCB): Rogers 4350B; ϵ_{r} = 3.66; thickness = 0.508 mm; thickness of copper plating = 35 μ m.

Fig 3. Component layout

Table 9. Demo test circuit list of components

See Figure 3 for component layout.

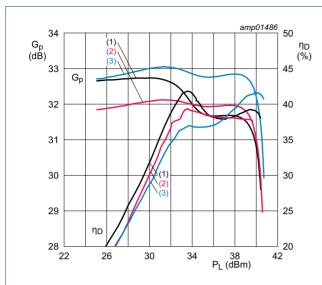
Component	Description	Value	Remarks
C1, C2, C3, C4, C5	multilayer ceramic chip capacitor	1 μF	11
C6	multilayer ceramic chip capacitor	1 μF	2]
X1	current sense resistor	100 mΩ, 1 W	Y44870R10000B0R

- [1] American Technical Ceramics type 600F or capacitor of same quality.
- [2] Murata or capacitor of same quality.

8.1 Ruggedness in a Doherty operation

The BLM9D3437-12AM is capable of withstanding a load mismatch corresponding to VSWR = 10 : 1 through all phases under the following conditions: V_{DS} = 28 V; I_{Dq} = 25 mA (carrier); $V_{GSq(peaking)} = V_{GSq(carrier)} - 0.55$ V; P_i corresponding to $P_{L(1dB)}$ under Z_S = 50 Ω load; f = 3400 MHz (CW); T_{case} = 25 °C.

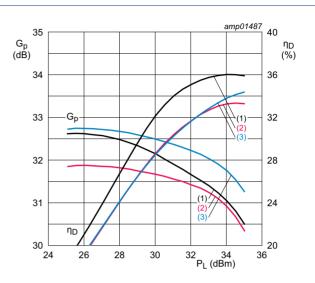
8.2 Graphs



 V_{DS} = 28 V; I_{Dq} = 25 mA; $V_{GS(amp)peak}$ = 1.44 V; t_{D} = 100 $\mu s;$ δ = 10 %.

- (1) f = 3400 MHz
- (2) f = 3550 MHz
- (3) f = 3700 MHz

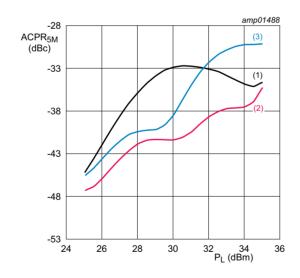
Fig 4. Power gain and drain efficiency as function of output power; typical values



 $V_{DS}=28~V;~I_{Dq}=25~mA;~V_{GS(amp)peak}=1.44~V.$ Test signal: 1-carrier W-CDMA; 3GPP test model 1; 64 DPCH; PAR = 7.2 dB at 0.01 % probability CCDF.

- (1) f = 3400 MHz
- (2) f = 3550 MHz
- (3) f = 3700 MHz

Fig 5. Power gain and drain efficiency as function of output power; typical values

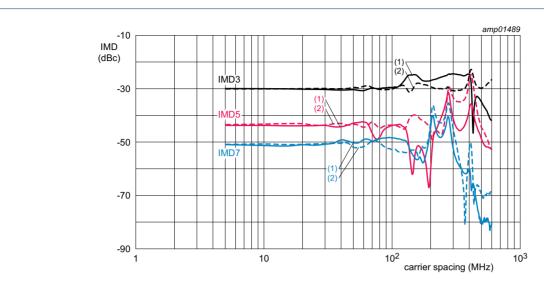


 $V_{DS} = 28 \text{ V}; I_{Dq} = 25 \text{ mA}; V_{GS(amp)peak} = 1.44 \text{ V}.$

Test signal: 1-carrier W-CDMA; 3GPP test model 1; 64 DPCH; PAR = 7.2 dB at 0.01 % probability CCDF.

- (1) f = 3400 MHz
- (2) f = 3550 MHz
- (3) f = 3700 MHz

Fig 6. Adjacent channel power ratio as a function of output power; typical values



 V_{DS} = 28 V; I_{Dq} = 25 mA; $V_{GS(amp)peak}$ = 1.44 V; f = 3550 MHz.

Test signal: 2-carrier CW.

- (1) IMD low
- (2) IMD high

Fig 7. VBW capability

9. Package outline

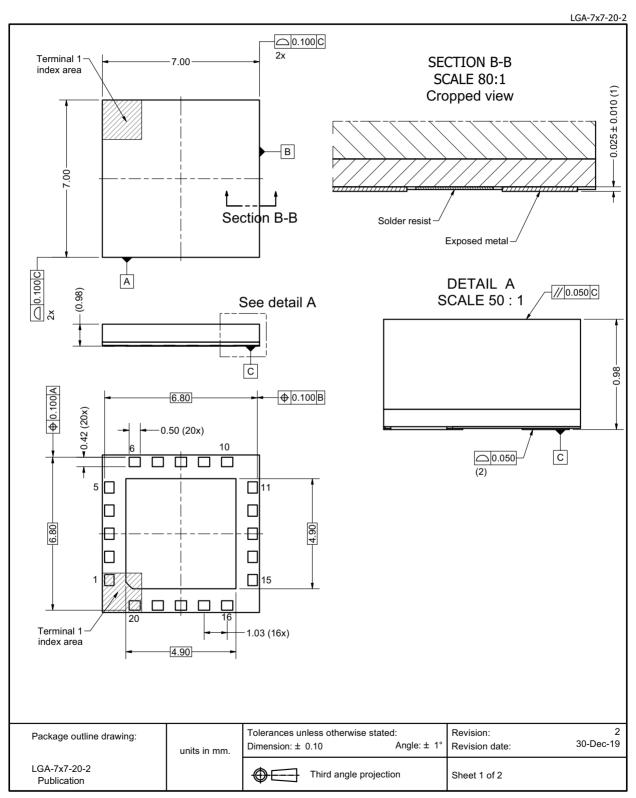


Fig 8. Package outline LGA-7x7-20-2 (sheet 1 of 2)

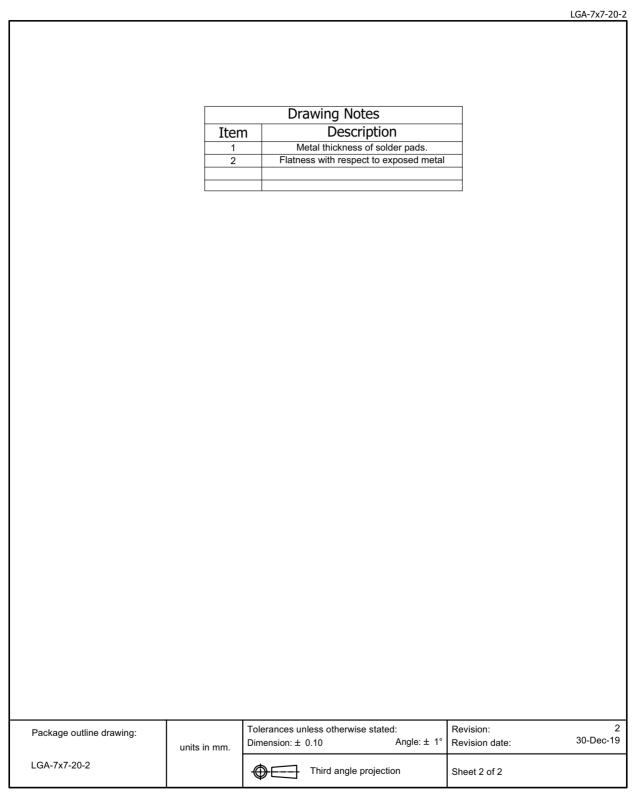


Fig 9. Package outline LGA-7x7-20-2 (sheet 2 of 2)

10. Handling information

CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Observe precautions for handling electrostatic sensitive devices.

Such precautions are described in the ANSI/ESD S20.20, IEC/ST 61340-5, JESD625-A or equivalent standards.

Table 10. ESD sensitivity

ESD model	Class
Charged Device Model (CDM); According to ANSI/ESDA/JEDEC standard JS-002	C2A [1]
Human Body Model (HBM); According to ANSI/ESDA/JEDEC standard JS-001	1C 2

- [1] CDM classification C2A is granted to any part that passes after exposure to an ESD pulse of 500 V.
- [2] HBM classification 1C is granted to any part that passes after exposure to an ESD pulse of 1000 V.

11. Abbreviations

Table 11. Abbreviations

Acronym	Description
3GPP	3rd Generation Partnership Project
CCDF	Complementary Cumulative Distribution Function
CW	Continuous Wave
DPCH	Dedicated Physical CHannel
ESD	ElectroStatic Discharge
GEN9	Ninth Generation
GSM	Global System for Mobile Communications
LDMOS	Laterally Diffused Metal Oxide Semiconductor
LTE	Long Term Evolution
MMIC	Monolithic Microwave Integrated Circuit
MTF	Median Time to Failure
NR	New Radio
ОВО	Output Back Off
PAR	Peak-to-Average Ratio
RoHS	Restriction of Hazardous Substances
VBW	Video Bandwidth
VSWR	Voltage Standing Wave Ratio
W-CDMA	Wideband Code Division Multiple Access

12. Revision history

Table 12. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BLM9D3437-12AM v.1	20200928	Product data sheet	-	-

BLM9D3437-12AM

13. Legal information

13.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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